



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**U.S. Serial No.:** 10/708,935  
**Inventor:** Todd P. Oman et al  
**Title:** MULTI-SUBSTRATE CIRCUIT ASSEMBLY  
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**Attorney Docket:** DP-311231

**CERTIFICATE OF MAILING OR TRANSMISSION**

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Nov 29, 2005  
Date

Kandace Brown  
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**AMENDMENT**

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed October 19, 2005, please amend the application as follows and consider the remarks set forth below.

|      |                             |        |
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